(Rev. 5-93)	U.S. Department of Commerce Petent And Trademark Office
1027 To the Honorable Commissioner of Patents and Trademarks: Please re	46196 ecord the attached original document or copy thereof.
1. Name of conveying party(ies): Date SHINICHI KURITA 12-14-99 WENDELL T. BLONIGAN 12-14-99 AKIHIRO HOSOKAWA 12-14-99	2. Name and address of receiving party(ies): Name: Applied Materials, Inc. Internal Address: P.O. Box 450-A
Additional name(s) of conveying party(ies) attached?YesX_ No	Street Address:
3. Nature of conveyance:	City: Santa Clara State: CA Zip: 95052
X Assignment Merger Security Agreement Change of Name Other	Additional name(s) & address(es) attached?Yes _X_ No
Execution Date: SEE ABOVE	-
4. Application number(s) or patent number(s): If this document is being filed together with a new application, the experiment of the second	xecution date of the application is: (Date of Filing)
Name and address of party to whom correspondence concerning document should be mailed: Name: Patent Counsel	Total number of applications and patents involved:1
Internal Address: APPLIED MATERIALS, INC.	7. Total fee (37 C.F.R. 3.41)
	— Authorized to be charged to deposit account
Street Address: P.O. Box 450-A City: Santa Clara State: CA Zip: 95052	8. Deposit account number: 20-0782
DO NOT	USE THIS SPACE
9. Statement and signature. To the best of my knowledge and belief, the foregoing information of KEITH TABOADA, Attorney Name of Person Signing Reg. No. 45,150	Total number of pages including cover sheet, attachments and document:
Comm	nd with required cover sheet information to: issioner of Patents P.O. Box 1450

40.00 DA

PATENT

REEL: 015321 FRAME: 0582

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	Shinichi Kurita 3532 Rollingside Drive San Jose, CA 95148	2)	Wendell T. Blonigan 32478 Monterey Drive Union City, CA 94587
3)	Akihiro Hosokawa 10264 Danube Drive Cupertino, CA 95014		

(hereinafter referred to as Assignors), have invented a certain invention entitled:

DUAL SUBSTRATE LOADLOCK PROCESS EQUIPMENT

for which applicat	tion for Letters Pa	atent in the United States was filed on 12/15/99	 '
under Serial No.	Unknown	_, executed on even date herewith; and	

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for

legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1) /2/14. 1999

2) 12/14 , 1999

3) _______, 1999

RECORDED: 05/10/2004

Shinichi Kurita

Wendell T. Blonigan

Akihiro Hosokawa